

In re the Application of: Kozo SHIMIZU et al.

Group Art Unit: 1742

Serial No.: 09/731,726

Examiner: Sikvin Ip

Filed: December 8, 2000

P.T.O. Confirmation No.: 1555

FOR: A SOLDER ALLOY, A CIRCUIT SUBSTRATE, A SEMICONDUCTOR DEVICE

AND A METHOD OF MANUFACTURING THE SAME

AMENDMENT UNDER 37 C.F.R. §1.111

Commissioner for Patents Washington, D.C. 20231

June 26, 2002

Sir:

In response to the Office Action dated March 27, 2002, please amend the above identified CHNOLOGY CENTER 1700 application as follows:

CLEAN VERSION OF AMENDMENTS

IN THE CLAIMS

Please add new claims 15 and 16 as follows:

15. (New) The semiconductor device of claim 1, said solder alloy being made from Sn prepared using a zone-melt method.

16. (New) The circuit substrate of claim 4, said solder alloy being made from Sn prepared using a zone-melt method.